Call for Papers

8th Japan–Korea Symposium on Materials & Interface

November 5-7, 2008 Sapporo, Japan



Organized by

Division of Materials and Interface &

Division of Reaction Engineering

The Society of Chemical Engineers, Japan (SCEJ)

Invitation

The Organizing Committee cordially invites you to participate in the 8th Japan-Korea Symposium on Materials and Interface to be held on November 5-7, 2008, in Sapporo, Japan. The main objectives of the symposium are to share the latest research results, to exchange ideas and to boost the cooperative relations among chemical engineers, chemists, and materials scientists and engineers of the two countries. The scope of the symposium will cover all aspects of materials research in chemical engineering, chemistry and materials science and engineering.

Mikio Konno Symposium Chair

Venue

The Symposium is to be held at Keio Plaza Hotel Sapporo (Tel.: +81-11-271-0111, FAX: +81-11-271-7943, http://www.keioplaza-sapporo.co.jp/Korean/) in a city which is one of Hokkaido's centers of "Food & Sightseeing", a place to entertain us with the superb quality of food as well as the charming sceneries (http://www.welcome.city.sapporo.jp/tourism/k/index.ht ml).

Call for Papers

The symposium consists of oral and presentations. poster Contributing authors are requested to submit a one-page extended abstract that includes the title of paper, author(s) and e-mail address of the corresponding author, and affiliations in pdf format. The extended abstract should be submitted to Prof. Minoru Miyahara (jksm2008@cheme.kvoto-u.ac.jp) of Kvoto University by e-mail telling the author's preference on the presentation style, oral or poster. Deadline for receiving abstracts is August 31, 2008. Authors whose abstract are accepted by the scientific committee will be informed by September 15, 2008.

Registration

Those who are planning to attend the symposium are kindly requested to complete the registration by October 15, 2008.

Registration: http://www.che.kyutech.ac.jp/chem22/dmi-scej/JKSMI2008

Tentative Schedule

- Nov. 5 Welcome Reception
- Nov. 6 Oral and Poster Presentations
 Banquet
- Nov. 7 Oral and Poster Presentations

Registration Fees

Symposium registration
Participants from Japan 17,000 JPY
Participants from Korea 170,000 KRW

Students Rate excluding Banquet
Students from Japan 5,000 JPY
Students from Korea 50,000 KRW
Banquet for students
5,000 JPY or 50,000 KRW

Accommodations

The symposium will be held at Keio Plaza Hotel Sapporo. The Organizing Committee will reserve rooms in the hotel for the participants.

Registration: http://www.che.kyutech.ac.jp/chem22/dmi-scej/JKSMI2008

Transportation

The hotel is located within 5 minutes' walk from JR Sapporo station, <40 minutes from New Chitose airport by JR Rapid Airport Express.

Excursion

One-day tour for sightseeing in and around Sapporo and Otaru is scheduled on November 8. Advanced registration is required.

Registration: http://www.che.kyutech.ac.jp/chem22/dmi-scej/JKSMI2008

Free trip to Hokkaido University will also be available during the symposium. No registration is required.



Prof. W.S. Clark
Founding Vice President of Sapporo Agricultural College
(Now, Hokkaido University)

Key Dates

August 31, 2008

One-page extended abstract submission

September 15, 2008

Letter of acceptance of paper

October 15, 2008

Registration on web

Symposium Chair

Mikio Konno (Tohoku Univ.)

Symposium Secretary

Tatsuya Okubo (The Univ. of Tokyo)

Organizing Committee

Ken-ichi Kurumada

(Yokohama National Univ.)

Shin Mukai (Hokkaido Univ.)

Akihisa Shioi (Doshisha Univ.)

Koichiro Shiomori (Univ. of Miyazaki)

Masahiro Shishido (Yamagata Univ.)

Masato Yamamura (Kyushu Inst. of Tech.)

Scientific Committee

Masahiro Kishida (Kyushu Univ.) Minoru Miyahara (Kyoto Univ.)

Ho-Suk Choi (Chungnam National Univ.)

Suk Woo Nam (KIST)

International Advisory Board

Ko Higashitani (Kyoto Univ.)

Yoshio Nakano (Tokyo Inst. of Tech.)

Shuji Sakohara (Hiroshima Univ.)

Kee Suk Nahm (Chonbuk National Univ.)

Seung Bin Park (KAIST)

Kun-Hong Lee (POSTECH)